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## **BIB DATA SHEET**

## **CONFIRMATION NO. 6904**

SERIAL NUM	BER	FILING OF		CLASS GF			ROUP ART UNIT		ATTORNEY DOCKET NO.	
10/552,04	-6	01/09/2			438		2829		Q74738	
		RUL	E							
APPLICANTS  Fung Leng Chen, Singapore, SINGAPORE; Seong Kwang Brandon Kim, Singapore, SINGAPORE; Wee Lim Cha, Singapore, SINGAPORE; Yi-Sheng Anthony Sun, Singapore, SINGAPORE; Wolfgang Hetzel, Natheim, GERMANY; Jochen Thomas, Munich, GERMANY;  ** CONTINUING DATA **********************************										
This application is a 371 of PCT/IB04/01734 04/02/2004										
** FOREIGN APPLICATIONS ************************************										
** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 03/31/2007										
Foreign Priority claimed Yes No  35 USC 119(a-d) conditions met Yes No Met after Allowance				STATE OR COUNTRY	_	IEETS WINGS	TOTAL CLAIMS		INDEPENDENT CLAIMS	
Verified and Acknowledged Acknowledged Examiner's Signature Thitials					SINGAPORE		10	9		2
ADDRESS										
SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W. SUITE 800 WASHINGTON, DC 20037 UNITED STATES										
TITLE										
Multi-chip ball grid array package and method of manufacture										
	FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT					☐ All Fees				
   FILING FEE							☐ 1.16 Fees (Filing)			
RECEIVED						NT	1.17 Fees (Processing Ext. of time)			
1030	No for following:						1.18 Fees (Issue)			
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